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**Vishay Semiconductors** 



# Hyperfast Rectifier, 8 A FRED Pt<sup>®</sup>





#### VS-8ETH06FP-N3

PRIMARY CHARACTERISTICS							
I <sub>F(AV)</sub> 8 A							
V <sub>R</sub>	600 V						
V <sub>F</sub> at I <sub>F</sub>	1.3 V						
t <sub>rr</sub> typ.	18 ns						
T <sub>J</sub> max.	175 °C						
Package	2L TO-220 FullPAK						
Circuit configuration	Single						

### **FEATURES**

- · Hyperfast recovery time
- · Low forward voltage drop
- 175 °C operating junction temperature
- Low leakage current
- Fully isolated package (V<sub>INS</sub> = 2500 V<sub>BMS</sub>)
- UL pending
- Designed and qualified according to JEDEC<sup>®</sup>-JESD 47
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### **DESCRIPTION / APPLICATIONS**

State of the art hyperfast recovery rectifiers designed with optimized performance of forward voltage drop, hyperfast recovery time, and soft recovery.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in PFC boost stage in the AC/DC section of SMPS, inverters or as freewheeling diodes.

Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Repetitive peak reverse voltage	V <sub>RRM</sub>		600	V			
Average rectified forward current	I <sub>F(AV)</sub>	T <sub>C</sub> = 108 °C	8				
Non-repetitive peak surge current	I <sub>FSM</sub>		100	А			
Repetitive peak forward current	I <sub>FM</sub>		16				
Operating junction and storage temperatures	T <sub>J</sub> , T <sub>Stg</sub>		-65 to +175	°C			

<b>ELECTRICAL SPECIFICATIONS</b> ( $T_J = 25 \text{ °C}$ unless otherwise specified)								
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS		
Breakdown voltage, blocking voltage	V <sub>BR</sub> , V <sub>R</sub>	I <sub>R</sub> = 100 μA		-	-			
Fam. and welters.	N	I <sub>F</sub> = 8 A	-	2.0	2.4	V		
Forward voltage V <sub>F</sub>		I <sub>F</sub> = 8 A, T <sub>J</sub> = 150 °C	-	1.3	1.8			
Deverse leckage current	I <sub>R</sub>	$V_{R} = V_{R}$ rated	-	0.3	50			
Reverse leakage current		$T_J = 150 \text{ °C}, V_R = V_R \text{ rated}$	-	55	500	μA		
Junction capacitance	CT	V <sub>R</sub> = 600 V	-	17	-	pF		
Series inductance	L <sub>S</sub>	Measured lead to lead 5 mm from package body - 8.0 -		nH				

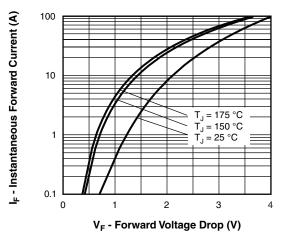
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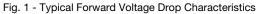
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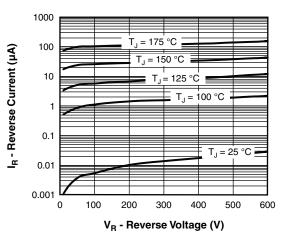


<b>DYNAMIC RECOVERY CHARACTERISTICS</b> (T <sub>C</sub> = 25 °C unless otherwise specified)								
PARAMETER	SYMBOL	TEST	CONDITIONS	MIN.	TYP.	MAX.	UNITS	
		$I_F = 1 \text{ A}, \ dI_F/dt = 100$	) A/µs, V <sub>R</sub> = 30 V	-	18	22		
Reverse recovery time	t <sub>rr</sub>	$I_F = 8 \text{ A}, \ dI_F/dt = 100$	) A/µs, V <sub>R</sub> = 30 V	-	20	25	ns	
neverse recovery time	۲r	T <sub>J</sub> = 25 °C		-	25	-	115	
		T <sub>J</sub> = 125 °C	I <sub>F</sub> = 8 A dI <sub>F</sub> /dt = 200 A/µs V <sub>R</sub> = 390 V	-	40	-		
Peak recovery current	I <sub>RRM</sub>	T <sub>J</sub> = 25 °C		-	2.4	-	А	
Feak recovery current		T <sub>J</sub> = 125 °C		-	4.8	-	~	
Boyorga racovany abarga	0	T <sub>J</sub> = 25 °C		-	25	-	nC	
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 125 °C		-	120	-		
Reverse recovery time	t <sub>rr</sub>		I <sub>F</sub> = 8 A	-	33	-	ns	
Peak recovery current	I <sub>RRM</sub>	T <sub>J</sub> = 125 °C	dl <sub>F</sub> /dt = 600 A/µs V <sub>R</sub> = 390 V	-	12	-	А	
Reverse recovery charge	Q <sub>rr</sub>			-	220	-	nC	

THERMAL - MECHANICAL SPECIFICATIONS								
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS		
Maximum junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		-65	-	175	°C		
Thermal resistance, junction-to-case	R <sub>thJC</sub>		-	3.4	4.3	°C/W		
Thermal resistance, junction-to-ambient per leg	R <sub>thJA</sub>	Typical socket mount	-	-	70			
Thermal resistance, case-to-heatsink	R <sub>thCS</sub>	Mounting surface, flat, smooth, and greased	-	0.5	-			
Weight			-	2.0	-	g		
Weight			-	0.07	-	oz.		
Mounting torque			6.0 (5.0)	-	12 (10)	kgf · cm (lbf · in)		
Marking device		Case style 2L TO-220 FullPAK	O-220 FullPAK 8ETH06FP					









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## VS-8ETH06FP-N3

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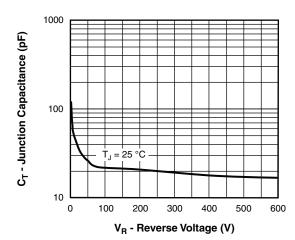
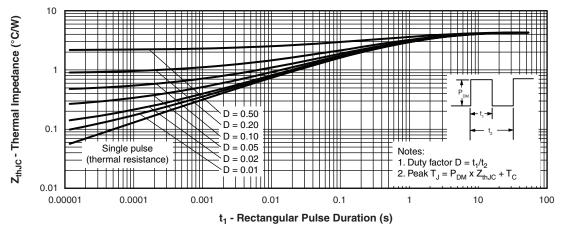
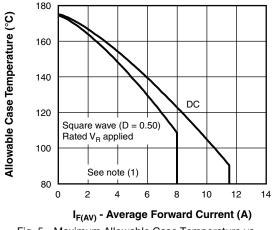


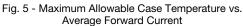
Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

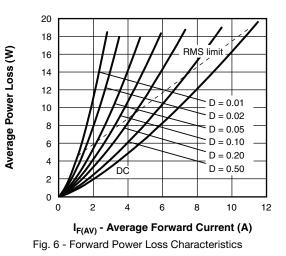






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### Note

<sup>(1)</sup> Formula used:  $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$ ;

 $\begin{array}{l} \mathsf{Pd} = \mathsf{forward} \ \mathsf{power} \ \mathsf{loss} = \mathsf{I}_{\mathsf{F}(\mathsf{AV})} \ \mathsf{x} \ \mathsf{V}_{\mathsf{FM}} \ \mathsf{at} \ (\mathsf{I}_{\mathsf{F}(\mathsf{AV})}/\mathsf{D}) \ (\mathsf{see} \ \mathsf{fig.} \ \mathsf{5}); \\ \mathsf{Pd}_{\mathsf{REV}} = \mathsf{inverse} \ \mathsf{power} \ \mathsf{loss} = \mathsf{V}_{\mathsf{R1}} \ \mathsf{x} \ \mathsf{I}_{\mathsf{R}} \ (\mathsf{1} \ \mathsf{-D}); \ \mathsf{I}_{\mathsf{R}} \ \mathsf{at} \ \mathsf{V}_{\mathsf{R1}} = \mathsf{rated} \ \mathsf{V}_{\mathsf{R}} \end{array}$ 

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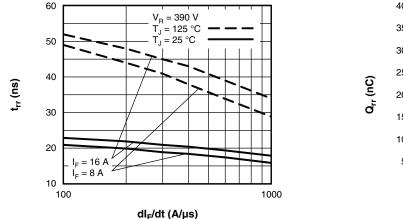


Fig. 7 - Typical Reverse Recovery Time vs. dl<sub>F</sub>/dt

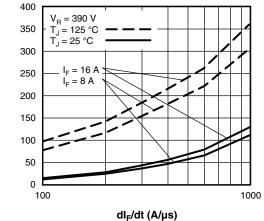


Fig. 8 - Typical Stored Charge vs. dl<sub>F</sub>/dt

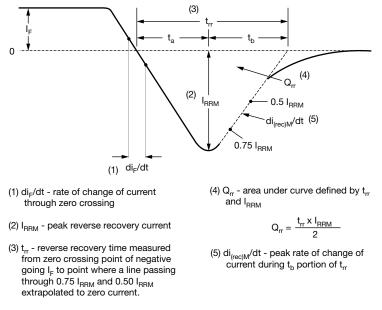


Fig. 9 - Reverse Recovery Waveform and Definitions



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### **ORDERING INFORMATION TABLE**

Device code	VS-	8	Е	т	н	06	FP	-N3
		(2)	(3)	(4)	(5)	(6)	(7)	(8)
	1 -	Visł	nay Serr	iconduc	ctors pro	oduct		
	2 -	Cur	rent rati	ng (8 = 8	8 A)			
	3 -	E =	single					
	4 -	T =	TO-220	, D <sup>2</sup> PAk	K (TO-26	SAB)		
	5 -	H =	hyperfa	st reco	/ery			
	6 -	Volt	age rati	ng (06 =	= 600 V)			
	7 -	FP	= 2L TO	-220 Fu	IIPAK			
	8 -	Env	ironmer	ntal digit	:			
		-N3	= halog	en-free,	RoHS-	complia	ant, and	l totally

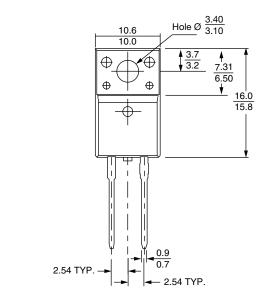
ORDERING INFORMATION (Example)							
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION				
VS-8ETH06FP-N3	50	1000	Antistatic plastic tube				

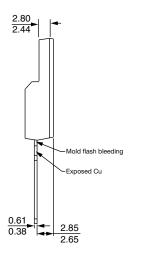
LINKS TO RELATED DOCUMENTS						
Dimensions	www.vishay.com/doc?96157					
Part marking information	www.vishay.com/doc?95392					

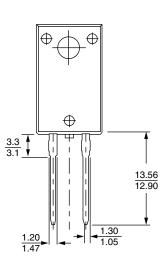


# 2L TO-220 FullPAK

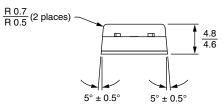
### **DIMENSIONS** in millimeters







Bottom view



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